## LI0805H400R-10

### PHYSICAL DIMENSIONS:

IMPEDANCE

A 2.00 [.079] ± 0.20 [.008]

1.25 [.049] ± 0.20 [.008]

0.90 [.035] ± 0.20 [.008]

± 0.25 [.010] D 0.51 [.020]

ELEC1	RICAL CHARACTERISTICS:				
Z @ 100MHz ( Ω )		DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current		
Nominal	40				
Minimum	30				
Maximum	50	0.15	800 mA		

NOTES: UNLESS OTHERWISE SPECIFIED

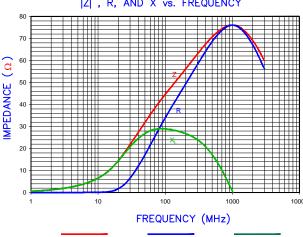
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)
- 5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

# FREQUENCY (MHz)

Z vs FREQUENCY

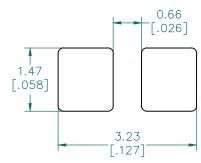
IMPEDANCE UNDER DC BIAS

### |Z| , R, AND X vs. FREQUENCY



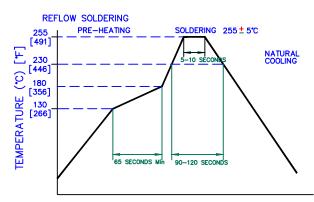
AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3298

### LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [.030] to this dimension.)

### RECOMMENDED SOLDERING CONDITIONS



DIMENSIONS ARE IN mm [INCHES].			This print is the property of Laird Tech. and is loaned in confidence					
				Tech. and is loaned in confidence subject to return upon request and				
				with the understanding that no		Laird		
F	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13		written consent of Laird Tech. All				
Ε	CHANGE TO PAPER TAPE	03/04/10	JUN	reserved.				
D	UPDATE COMPANY LOGO	07/21/08	JRK	PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:	
С	REACTIVATE PRINT AND UPDATE COMPANY LOGO	08/10/07	тмв	LI0805H400R-10	F	CO-FIRE	тмв	
В	REACTIVATE PRINT REVISE NOTE 1	10/12/06	TMB	DATE: 03/24/04 S	CALE:	NTS SHEET:		
Α	ORIGINAL DRAFT	03/24/04	TMB	CAD #	OOL #			
REV	DESCRIPTION	DATE	INT	"LI0805H400R-10-F		- 1	of 1	

